

## PATENT ASSIGNMENT COVER SHEET

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|   |                            |                       |
|---|----------------------------|-----------------------|
| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT             |                       |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                 |                       |
| <b>CONVEYING PARTY DATA</b>   |                            |                       |
|   | <b>Name</b>                | <b>Execution Date</b> |
|   | KENNETH J. SUSNJARA        | 04/22/2021            |
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| <b>City:</b>  | DALE                       |                       |
| <b>State/Country:</b>   | INDIANA                    |                       |
| <b>Postal Code:</b>   | 47523-9057                 |                       |
| <b>PROPERTY NUMBERS Total: 1</b>  |                            |                       |
| <b>Property Type</b>  | <b>Number</b>              |                       |
| <b>Application Number:</b>  | 17661202                   |                       |
| <b>CORRESPONDENCE DATA</b>  |                            |                       |
| <b>Fax Number:</b>  |                            |                       |
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| <b>ATTORNEY DOCKET NUMBER:</b>  | 00132-0098-01000           |                       |
| <b>NAME OF SUBMITTER:</b>   | MATTHEW J. SEWARD          |                       |
| <b>SIGNATURE:</b>   | /Matthew J. Seward/        |                       |
| <b>DATE SIGNED:</b>   | 05/02/2022                 |                       |
| <b>Total Attachments: 1</b>   |                            |                       |
| source=Parent Exe Assignment#page1.tif  |                            |                       |

## ASSIGNMENT

WHEREAS I, the below named inventor (hereinafter referred to as Assignor), have made an invention entitled:

### METHOD OF PRODUCING PATTERNS, MOLDS, AND RELATED PRODUCTS

for which I executed a non-provisional application for United States Letters Patent that will be or has been filed in the U.S. Patent and Trademark Office ("USPTO"); and

WHEREAS, **Thermwood Corporation**, a corporation of Indiana, whose post office address is **904 Dale-Bufferville Road, Dale, Indiana 47523-9057** (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, the above-identified non-provisional application for United States Letters Patent, the Letters Patent to be issued upon this non-provisional application, and/or any application claiming priority to this non-provisional application;

NOW THEREFORE, be it known that, for good and valuable consideration, the receipt of which from Assignee is hereby acknowledged, I, as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention, this non-provisional application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above non-provisional application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all non-provisional, divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, I HEREBY authorize the attorneys/representatives that I have empowered to prosecute this application to insert here in parentheses the country, application number, and official filing date ( U.S. Application No. 17/322,477, filed May 17, 2021 ).

Name: Kenneth J. SUSNJARA  
Address: c/o Thermwood Corporation  
904 Dale-Bufferville Road  
Dale, IN 47523-9057  
By: [Signature]  
Date: 5/22/21